NAVOLCHI 1st Review Meeting

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Nano Scale Disruptive Silicon-Plasmonic Platform for Chip-to-Chip Interconnection

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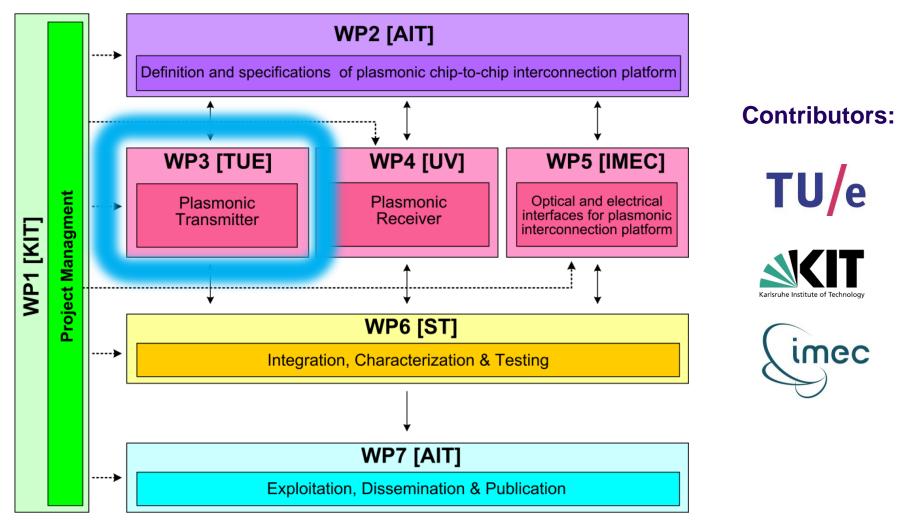
Outline



- 1. WP3 Position in Project
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 - I. Plasmonic/Metallic Laser
 - Status of Work
 - Summary and Outlook
 - **II. Plasmonic Modulator**
 - Status of Work
 - Summary and Outlook
- 5. Resources: Budget and Manpower

WP3 Position in Project





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WP3 Objectives



- **Simulation studies** to optimize
 - Plasmonic/metallic nanolaser
 - Plasmonic modulator
- Fabrication
 - Electrically pumped plasmonic/metallic nanolaser
 - Electrically driven plasmonic modulator
- Performance targets
 - Laser: active region < 1 μm^2 , output power > 100 μW
 - Modulator: extinction ratio > 10 dB for length < 10 μm , and modulation speed > 40 Gbit/s

Milestones



Nanolaser (TU/e)

	Name of milestone	Month
MS8	Decision on an optimized structure for metallic/plasmonic nanolaser and its coupling to a Si-waveguide	6
MS10	Grown wafer structure for plasmonic lasers	12
MS13	Initial characterization of unbonded plasmonic lasers	18
MS15	Initial testing of bonded plasmonic lasers	24



Milestones



Plasmonic Modulator (KIT)

	Name of milestone	Month
MS9	Decision on an optimized structure for plasmonic modulator	6
MS11	Fabrication of plasmonic modulator on a SOI platform	15
MS12	Decision on an optimized structure for plasmonic modulator with a maximum loss of 20dB	18
MS14	Initial testing and characterization of plasmonic modulators	21



Deliverables



Nanolaser (TU/e)

	Name of deliverable	Month
D3.1	Report on studies of optimized structure for metallic/plasmonic nanolaser and its coupling to Si-waveguide	12
D3.3	Fabrication of plasmonic laser device	24

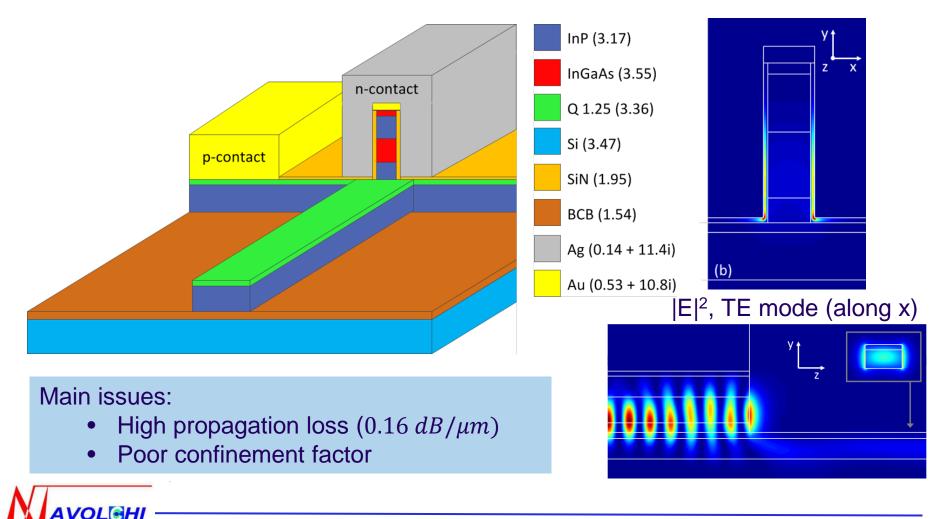
Plasmonic modulator (KIT)

	Name of deliverable	Month
D3.2	Report on modelling of the modulator structure	12
D3.4	Report on fabrication of modulators	24

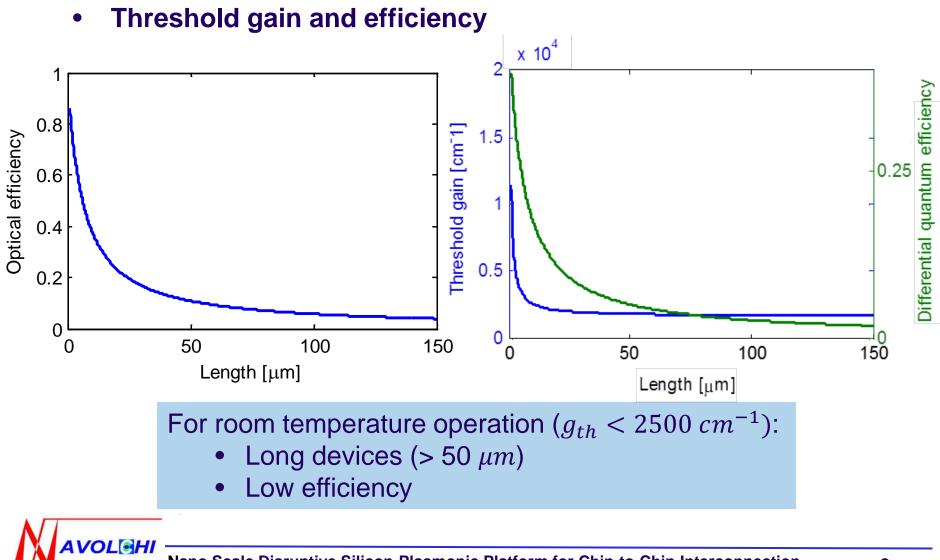




• Plasmonic laser design

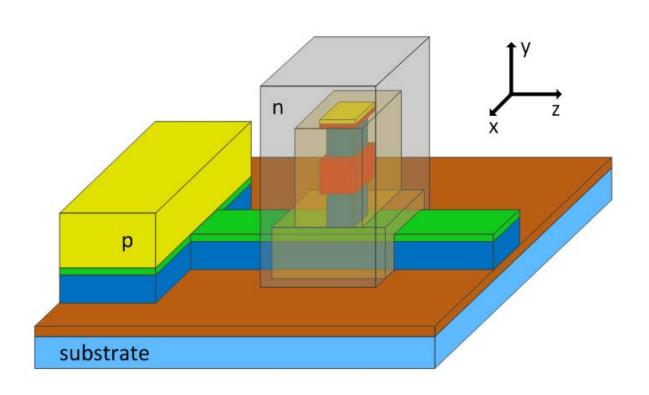


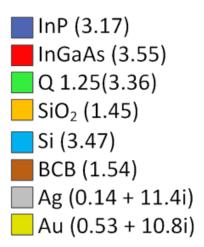




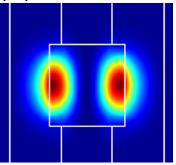


Metallo-dielectric nanolaser





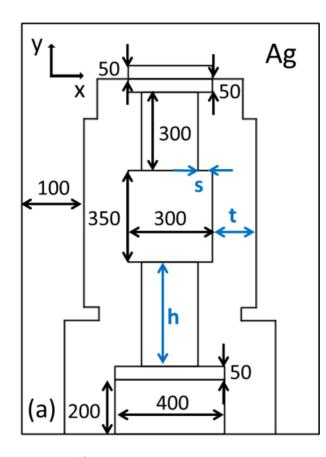


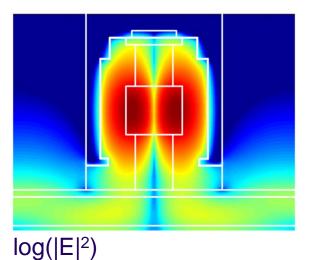






• Optimization for high Q-factor and high coupling efficiency



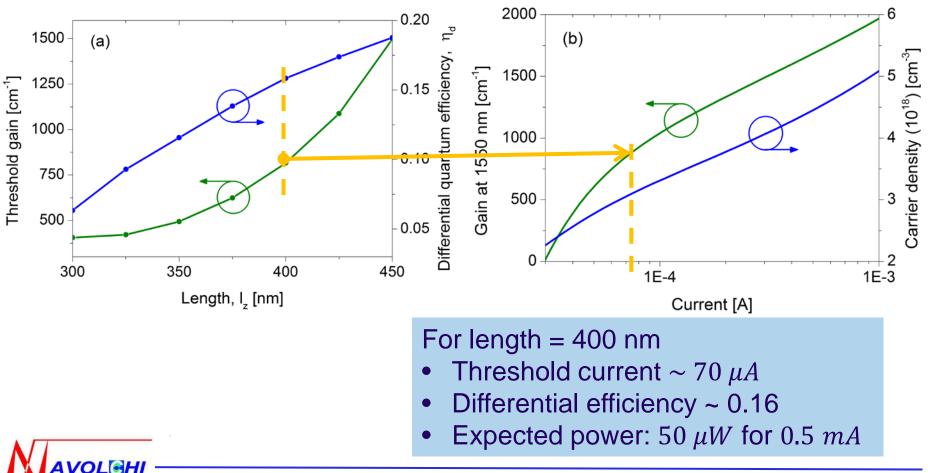


- Q-factor mainly depends on undercut *s*, bottom post *h* and insulation thickness *t*
- Coupling efficiency depends on device length l_z





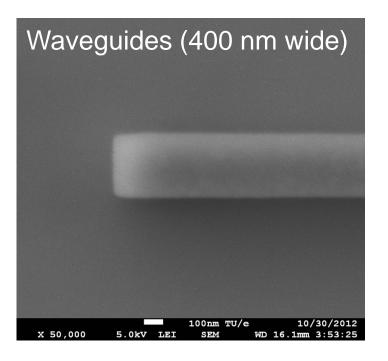
Calculated threshold gain and current

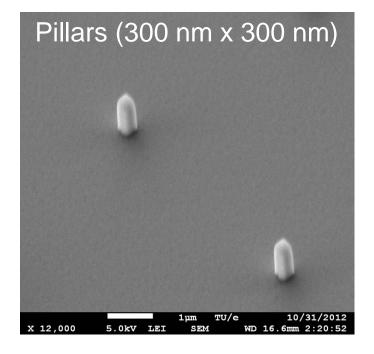




• Fabrication started

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Summary and Outlook: Nanolaser



• Summary

- A Fabry Perot plasmonic laser and a metallodielectric nanolaser have studied and optimized for operation near 1.55 μm
- The metallo-dielectric laser has found to offer a better performance
- Fabrication of the metallo-dielectric laser has started First etched individual pillars and waveguides

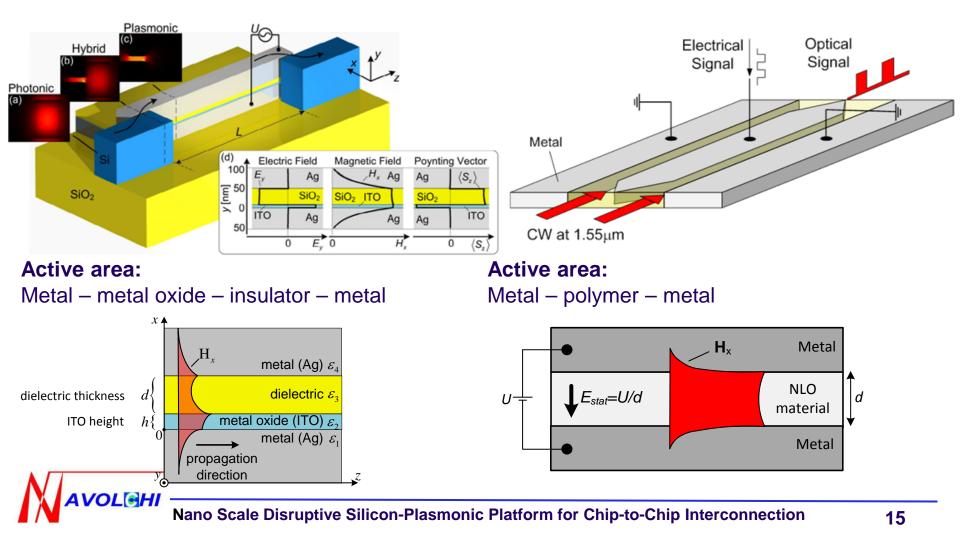
• Outlook

- Further study of metallo-dielectric lasers with length of few micrometers to get higher output power
- Bonding of InP wafers to Si wafers by IMEC
- Continue fabrication activities
- Characterization of nanolasers



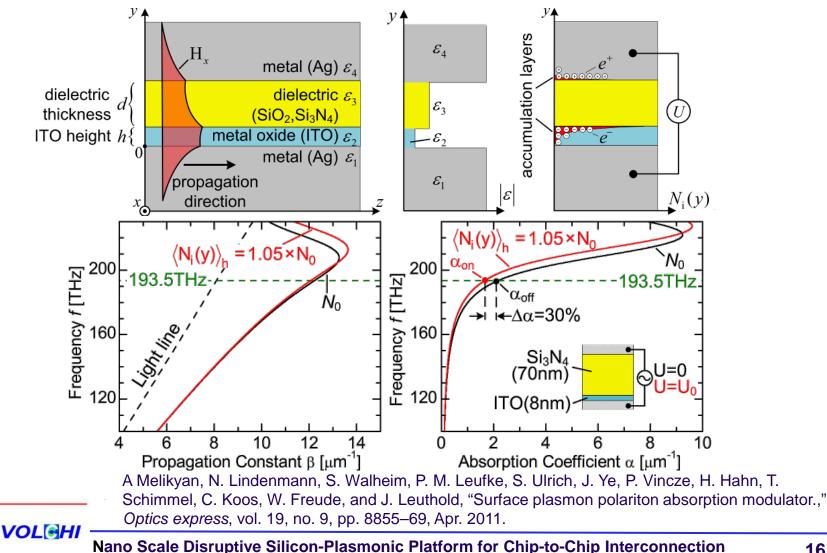
SPP Absorption Modulator

• SPP Phase Modulator



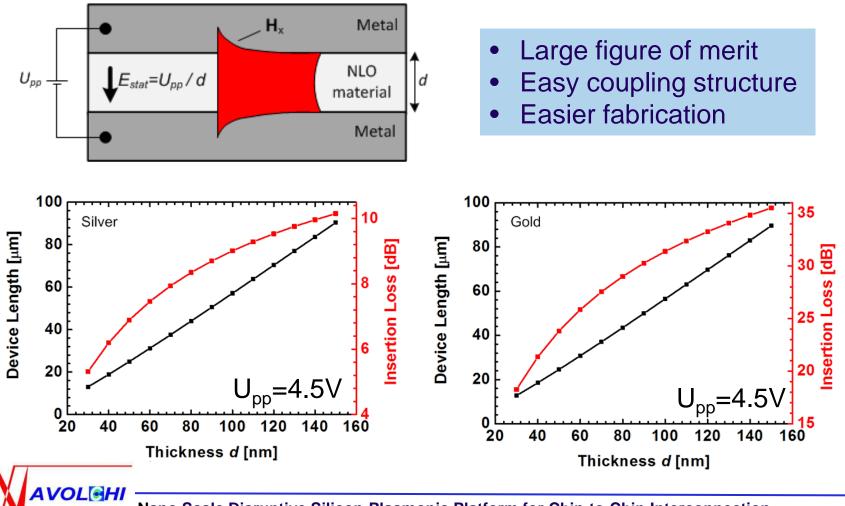


SPP Absorption Modulator

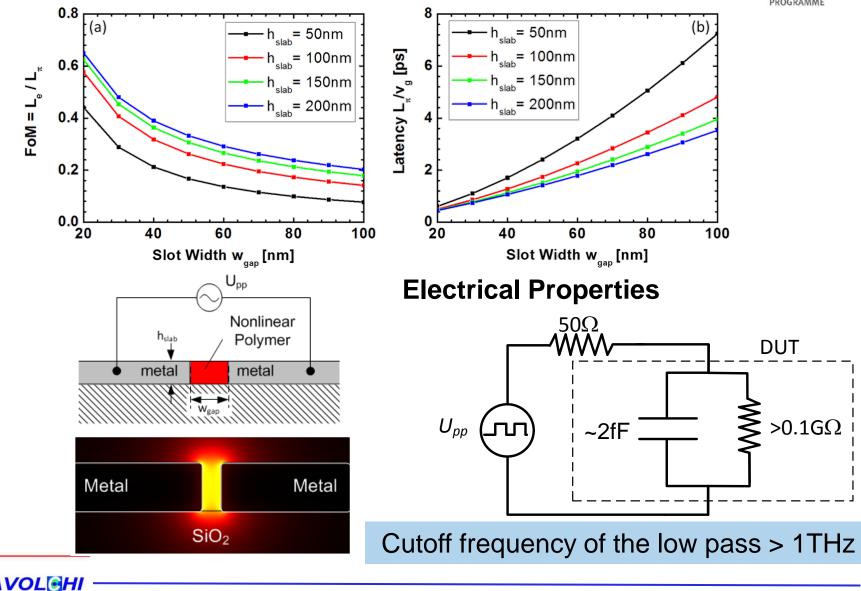




• SPP Phase Modulator



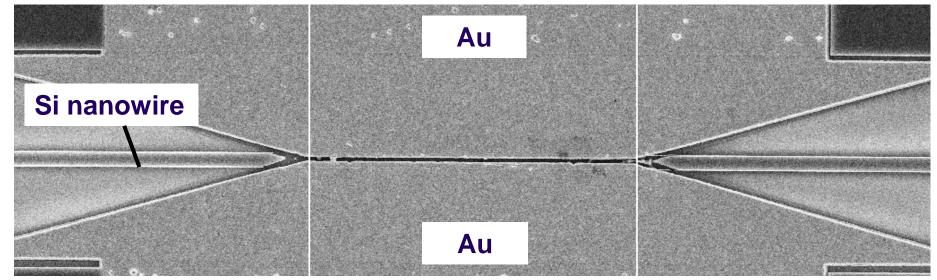


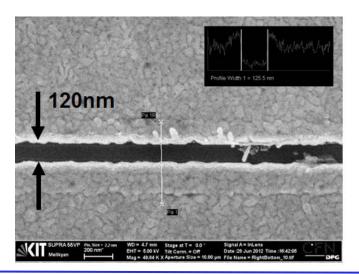




• SEM image of the device

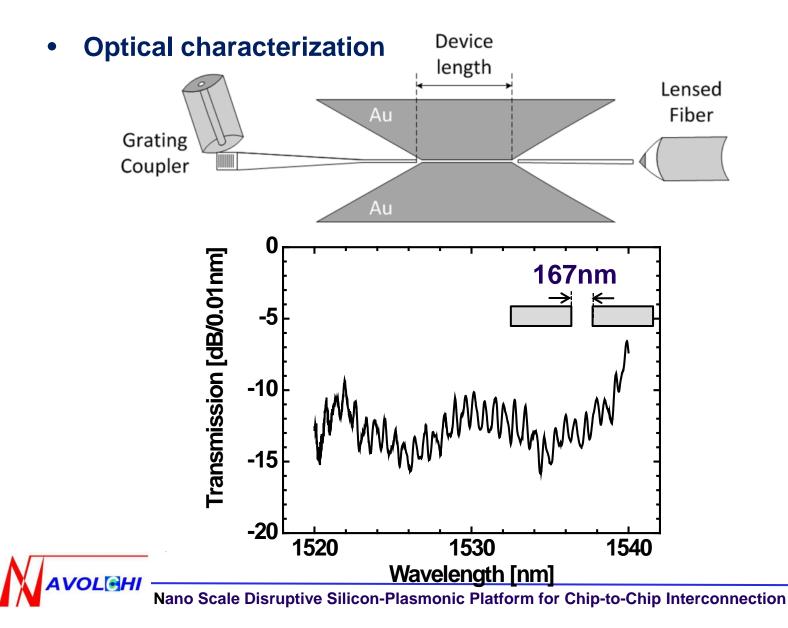
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Fabrication by KIT and IMEC





Summary and Outlook: Modulator



• Summary

- Absorption and phase modulators are optimized for $\lambda = 1.55 \ \mu m$ operation. It has been decided to fabricate the phase modulator
- One wafer has been processed by IMEC and postprocessed by KIT
- First optical characterizations have been carried out
- Outlook
 - Further optimization of fabrication process
 - Next post-processing is being carried out by KIT
 - Coating with electro-optic polymer
 - Characterization of modulators

Resources: Budget and Man Power



• Not yet available...





- 1) Should we present only the details of selected devices (laser and modulator) in order to shorten the presentation?
- 2) Should we merge MS13 and MS15? Is it important to decide this before the review meeting?
 - MS13: characterization of unbonded lasers (Month 18)
 - MS15: characterization of bonded lasers (Month 24)

